

CoolSiC™ Hybrid Discrete - TRENCHSTOP™ 5 H5 IGBT co-packed with half-rated 6th generation CoolSiC™ diode

Features

- $V_{CE} = 650\text{ V}$
- $I_C = 75\text{ A}$
- Ultra-low switching losses due to the combination of TRENCHSTOP™ 5 and CoolSiC™ technology
- Benchmark efficiency in hard switching topologies
- Plug-and-play replacement of pure silicon devices
- Maximum junction temperature $T_{vjmax} = 175^\circ\text{C}$
- Qualified according to JEDEC for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

Potential applications

- Industrial SMPS
- Industrial UPS
- Solar string inverter
- Energy storage
- Charger

Product validation

- Qualified for applications listed above based on the test conditions in the relevant tests of JEDEC20/22

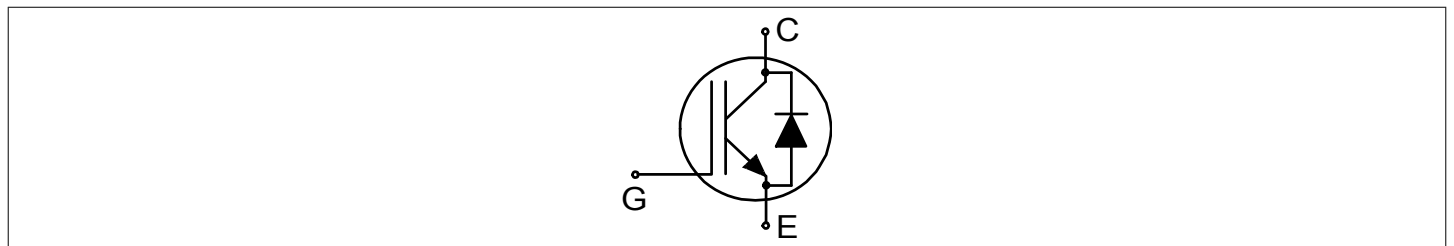
Description

Package pin definition:

- Pin G - gate
- Pin C & backside - collector
- Pin E - emitter



- Lead-free
- Green
- Halogen-free
- RoHS



| Type | Package | Marking |
|-------------|------------|---------|
| IKW75N65RH5 | PG-TO247-3 | K75ERH5 |

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1 Package

Table 1 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|---|---------------|--|--------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Internal emitter inductance measured 5 mm (0.197 in.) from case | L_E | | | 13.0 | | nH |
| Storage temperature | T_{stg} | | -55 | | 150 | °C |
| Soldering temperature | | wave soldering 1.6 mm (0.063 in.) from case for 10 s | | | 260 | °C |
| Mounting torque | M | M3 screw Maximum of mounting process: 3 | | | 0.6 | Nm |
| Thermal resistance, junction-ambient | $R_{th(j-a)}$ | | | | 40 | K/W |

2 IGBT

Table 2 Maximum rated values

| Parameter | Symbol | Note or test condition | Values | Unit | |
|--|--------------|---|-----------------------|------|---|
| Collector-emitter voltage | V_{CE} | $T_{vj} \geq 25\text{ °C}$ | 650 | V | |
| DC collector current, limited by T_{vjmax} | I_C | limited by bondwire | $T_c = 25\text{ °C}$ | 80 | A |
| | | | $T_c = 100\text{ °C}$ | 75 | |
| Pulsed collector current, t_p limited by T_{vjmax} | I_{Cpulse} | | 300 | A | |
| Turn-off safe operating area | | $V_{CE} \leq 650\text{ V}$, $t_p = 1\text{ }\mu\text{s}$, $T_{vj} \leq 175\text{ °C}$ | 300 | A | |
| Gate-emitter voltage | V_{GE} | | ± 20 | V | |
| Transient gate-emitter voltage | V_{GE} | $t_p \leq 10\text{ }\mu\text{s}$, $D < 0.01$ | ± 30 | V | |
| Power dissipation | P_{tot} | | $T_c = 25\text{ °C}$ | 395 | W |
| | | | $T_c = 100\text{ °C}$ | 198 | |

Table 3 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit | |
|--------------------------------------|-------------|--|--------------------------|------|------|------|---|
| | | | Min. | Typ. | Max. | | |
| Collector-emitter saturation voltage | V_{CEsat} | $I_C = 75\text{ A}$, $V_{GE} = 15\text{ V}$ | $T_{vj} = 25\text{ °C}$ | | 1.65 | 2.1 | V |
| | | | $T_{vj} = 125\text{ °C}$ | | 1.85 | | |
| | | | $T_{vj} = 175\text{ °C}$ | | 1.95 | | |
| Gate-emitter threshold voltage | V_{GEth} | $I_C = 0.75\text{ mA}$, $V_{CE} = V_{GE}$ | 3.2 | 4 | 4.8 | V | |

(table continues...)

Table 3 (continued) Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit | |
|-------------------------------------|--------------|--|---|------|------|------|---------------|
| | | | Min. | Typ. | Max. | | |
| Zero gate-voltage collector current | I_{CES} | $V_{CE} = 650 \text{ V}, V_{GE} = 0 \text{ V}$ | $T_{vj} = 25 \text{ }^\circ\text{C}$ | | | 1000 | μA |
| | | | $T_{vj} = 175 \text{ }^\circ\text{C}$ | | 2500 | | |
| Zero gate-voltage collector current | I_{CES} | $V_{CE} = 480 \text{ V}, V_{GE} = 0 \text{ V}$ | $T_{vj} = 25 \text{ }^\circ\text{C}$ | | | 30 | μA |
| Gate-emitter leakage current | I_{GES} | $V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}$ | | | | 100 | nA |
| Transconductance | g_{fs} | $I_C = 75 \text{ A}, V_{CE} = 20 \text{ V}$ | | 105 | | | S |
| Input capacitance | C_{ies} | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 250 \text{ kHz}$ | | 4000 | | | pF |
| Output capacitance | C_{oes} | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 250 \text{ kHz}$ | | 460 | | | pF |
| Reverse transfer capacitance | C_{res} | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 250 \text{ kHz}$ | | 15 | | | pF |
| Gate charge | Q_G | $I_C = 75 \text{ A}, V_{GE} = 15 \text{ V}, V_{CC} = 520 \text{ V}$ | | 168 | | | nC |
| Turn-on delay time | $t_{d(on)}$ | $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_{Gon} = 9 \text{ } \Omega, R_{Goff} = 9 \text{ } \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 30 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 37.5 \text{ A}$ | | 26 | | ns |
| | | | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 7.5 \text{ A}$ | | 26 | | |
| | | | $T_{vj} = 150 \text{ }^\circ\text{C}, I_C = 37.5 \text{ A}$ | | 24 | | |
| | | | $T_{vj} = 150 \text{ }^\circ\text{C}, I_C = 7.5 \text{ A}$ | | 20 | | |
| Rise time (inductive load) | t_r | $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_{Gon} = 9 \text{ } \Omega, R_{Goff} = 9 \text{ } \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 30 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 37.5 \text{ A}$ | | 9 | | ns |
| | | | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 7.5 \text{ A}$ | | 3 | | |
| | | | $T_{vj} = 150 \text{ }^\circ\text{C}, I_C = 37.5 \text{ A}$ | | 12 | | |
| | | | $T_{vj} = 150 \text{ }^\circ\text{C}, I_C = 7.5 \text{ A}$ | | 5 | | |
| Turn-off delay time | $t_{d(off)}$ | $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_{Gon} = 9 \text{ } \Omega, R_{Goff} = 9 \text{ } \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 30 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 37.5 \text{ A}$ | | 180 | | ns |
| | | | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 7.5 \text{ A}$ | | 220 | | |
| | | | $T_{vj} = 150 \text{ }^\circ\text{C}, I_C = 37.5 \text{ A}$ | | 205 | | |
| | | | $T_{vj} = 150 \text{ }^\circ\text{C}, I_C = 7.5 \text{ A}$ | | 240 | | |

(table continues...)

Table 3 (continued) Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit | |
|--|---------------|--|--|------|------|------------------|----|
| | | | Min. | Typ. | Max. | | |
| Fall time (inductive load) | t_f | $V_{CC} = 400\text{ V}, V_{GE} = 15\text{ V},$ $R_{Gon} = 9\ \Omega, R_{Goff} = 9\ \Omega,$ $L_\sigma = 30\text{ nH}, C_\sigma = 30\text{ pF}$ | $T_{vj} = 25\text{ }^\circ\text{C},$ $I_C = 37.5\text{ A}$ | | 15 | | ns |
| | | | $T_{vj} = 25\text{ }^\circ\text{C},$ $I_C = 7.5\text{ A}$ | | 35 | | |
| | | | $T_{vj} = 150\text{ }^\circ\text{C},$ $I_C = 37.5\text{ A}$ | | 18 | | |
| | | | $T_{vj} = 150\text{ }^\circ\text{C},$ $I_C = 7.5\text{ A}$ | | 40 | | |
| Turn-on energy | E_{on} | $V_{CC} = 400\text{ V}, V_{GE} = 15\text{ V},$ $R_{Gon} = 9\ \Omega, R_{Goff} = 9\ \Omega,$ $L_\sigma = 30\text{ nH}, C_\sigma = 30\text{ pF}$ | $T_{vj} = 25\text{ }^\circ\text{C},$ $I_C = 37.5\text{ A}$ | | 0.36 | | mJ |
| | | | $T_{vj} = 25\text{ }^\circ\text{C},$ $I_C = 7.5\text{ A}$ | | 0.07 | | |
| | | | $T_{vj} = 150\text{ }^\circ\text{C},$ $I_C = 37.5\text{ A}$ | | 0.45 | | |
| | | | $T_{vj} = 150\text{ }^\circ\text{C},$ $I_C = 7.5\text{ A}$ | | 0.09 | | |
| Turn-off energy | E_{off} | $V_{CC} = 400\text{ V}, V_{GE} = 15\text{ V},$ $R_{Gon} = 9\ \Omega, R_{Goff} = 9\ \Omega,$ $L_\sigma = 30\text{ nH}, C_\sigma = 30\text{ pF}$ | $T_{vj} = 25\text{ }^\circ\text{C},$ $I_C = 37.5\text{ A}$ | | 0.3 | | mJ |
| | | | $T_{vj} = 25\text{ }^\circ\text{C},$ $I_C = 7.5\text{ A}$ | | 0.08 | | |
| | | | $T_{vj} = 150\text{ }^\circ\text{C},$ $I_C = 37.5\text{ A}$ | | 0.4 | | |
| | | | $T_{vj} = 150\text{ }^\circ\text{C},$ $I_C = 7.5\text{ A}$ | | 0.11 | | |
| Total switching energy | E_{ts} | $V_{CC} = 400\text{ V}, V_{GE} = 15\text{ V},$ $R_{Gon} = 9\ \Omega, R_{Goff} = 9\ \Omega,$ $L_\sigma = 30\text{ nH}, C_\sigma = 30\text{ pF}$ | $T_{vj} = 25\text{ }^\circ\text{C},$ $I_C = 37.5\text{ A}$ | | 0.66 | | mJ |
| | | | $T_{vj} = 25\text{ }^\circ\text{C},$ $I_C = 7.5\text{ A}$ | | 0.15 | | |
| | | | $T_{vj} = 150\text{ }^\circ\text{C},$ $I_C = 37.5\text{ A}$ | | 0.85 | | |
| | | | $T_{vj} = 150\text{ }^\circ\text{C},$ $I_C = 7.5\text{ A}$ | | 0.2 | | |
| IGBT thermal resistance, junction-case | $R_{th(j-c)}$ | | | | 0.38 | K/W | |
| Operating junction temperature | T_{vj} | | -40 | | 175 | $^\circ\text{C}$ | |

3 Diode

Table 4 Maximum rated values

| Parameter | Symbol | Note or test condition | Values | Unit | |
|--|--------------|----------------------------|-----------------------|------|---|
| Repetitive peak reverse voltage | V_{RRM} | $T_{vj} \geq 25\text{ °C}$ | 650 | V | |
| Diode forward current, limited by T_{vjmax} | I_F | | $T_c = 25\text{ °C}$ | 45.7 | A |
| | | | $T_c = 100\text{ °C}$ | 30.7 | |
| Diode pulsed current, t_p limited by T_{vjmax} ¹⁾ | I_{Fpulse} | | 112.5 | A | |

1) Pulse current level depends on T_{vj} of diode chip, see also Fig. "Maximum pulse current as a function of junction temperature"

Table 5 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit | |
|---|---------------|------------------------|--------|--------------------------|------|------|---|
| | | | Min. | Typ. | Max. | | |
| Diode forward voltage | V_F | $I_F = 30\text{ A}$ | | $T_{vj} = 25\text{ °C}$ | 1.35 | 1.5 | V |
| | | | | $T_{vj} = 125\text{ °C}$ | 1.55 | | |
| | | | | $T_{vj} = 175\text{ °C}$ | 1.65 | | |
| Diode thermal resistance, junction-case | $R_{th(j-c)}$ | | | | 1.2 | K/W | |
| Operating junction temperature | T_{vj} | | -40 | | 175 | °C | |

Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

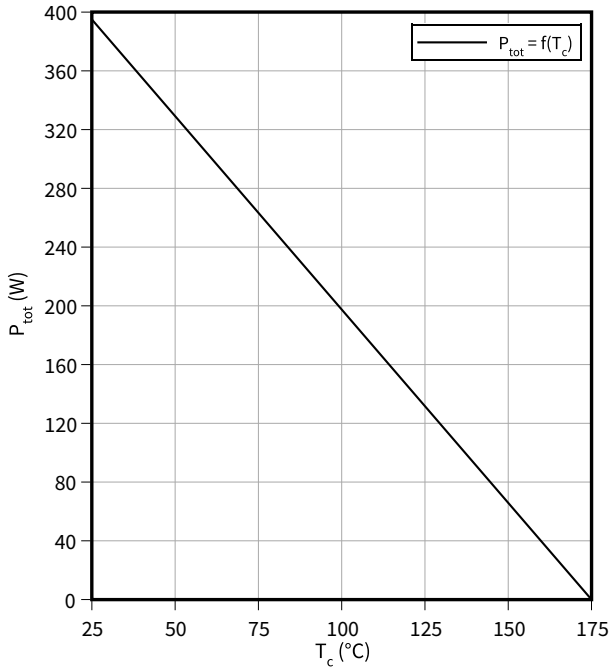
Electrical Characteristic at $T_{vj} = 25\text{ °C}$, unless otherwise specified.

Dynamic test circuit, parasitic inductance L_σ , parasitic capacitor C_σ from Fig. E. Energy losses include "tail" and diode reverse recovery.

4 Characteristics diagrams

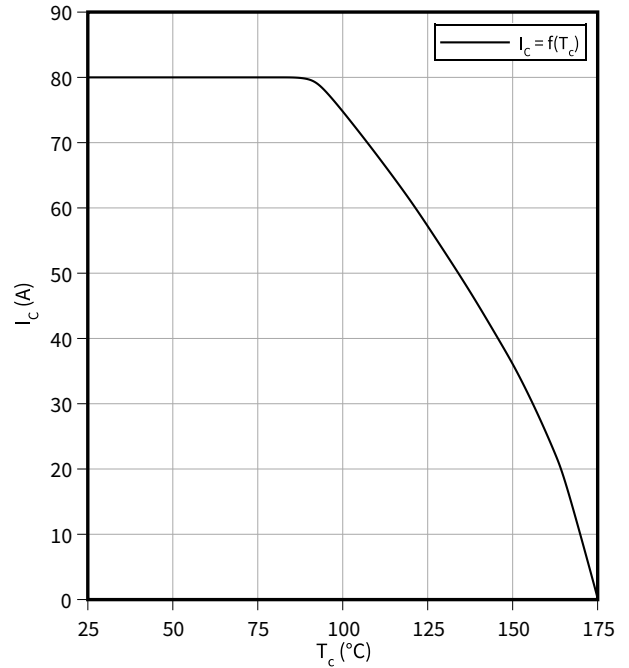
Power dissipation as a function of case temperature

$P_{tot} = f(T_c)$
 $T_{vj} \leq 175\text{ °C}$



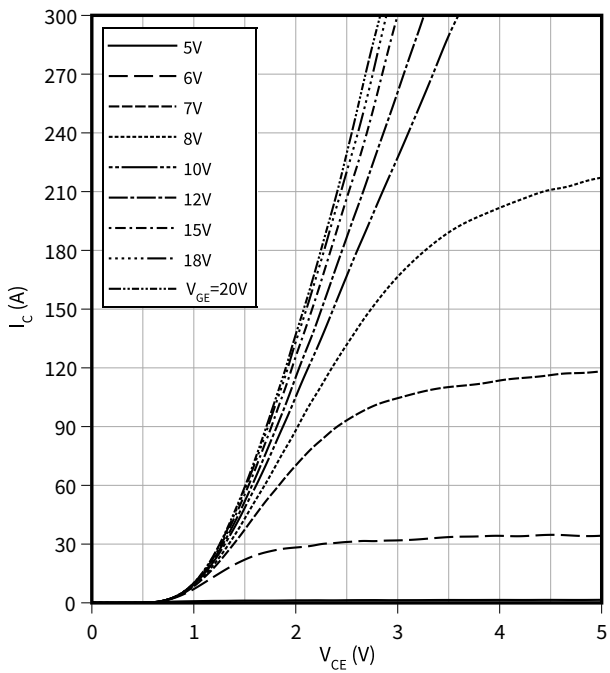
Collector current as a function of case temperature

$I_C = f(T_c)$
 $T_{vj} \leq 175\text{ °C}, V_{GE} \geq 15\text{ V}$



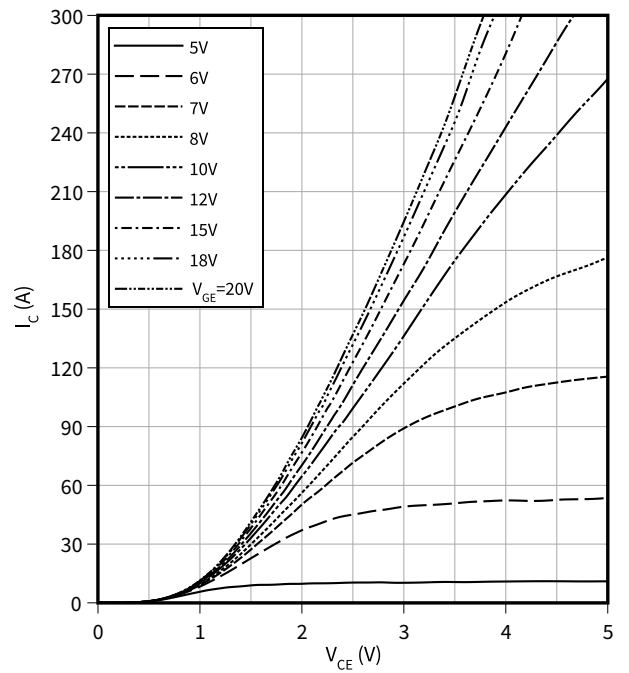
Typical output characteristic

$I_C = f(V_{CE})$
 $T_{vj} = 25\text{ °C}$



Typical output characteristic

$I_C = f(V_{CE})$
 $T_{vj} = 150\text{ °C}$

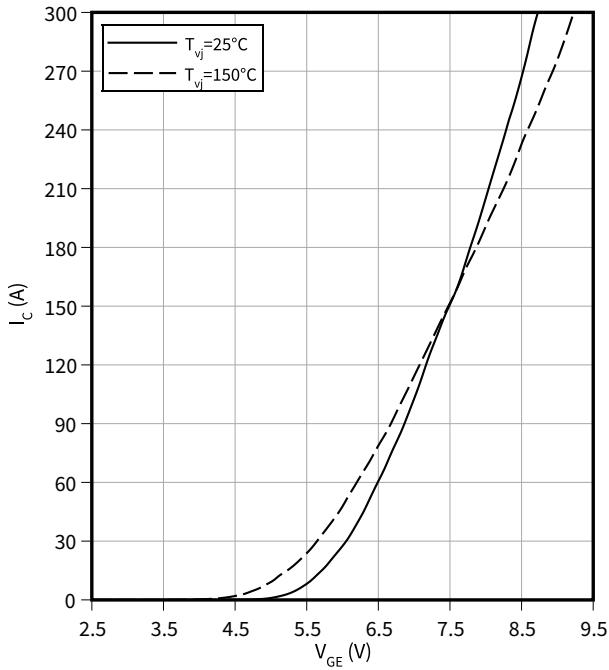


4 Characteristics diagrams

Typical transfer characteristic

$I_C = f(V_{GE})$

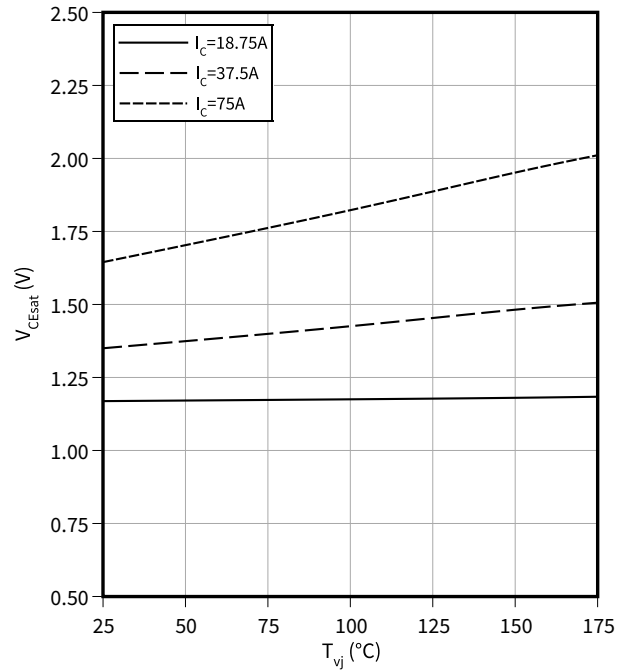
$V_{CE} = 20 \text{ V}$



Typical collector-emitter saturation voltage as a function of junction temperature

$V_{CEsat} = f(T_{vj})$

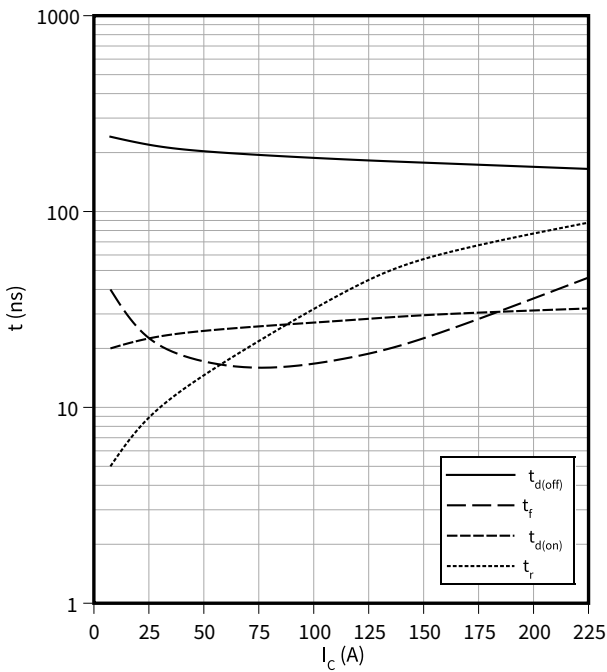
$V_{GE} = 15 \text{ V}$



Typical switching times as a function of collector current

$t = f(I_C)$

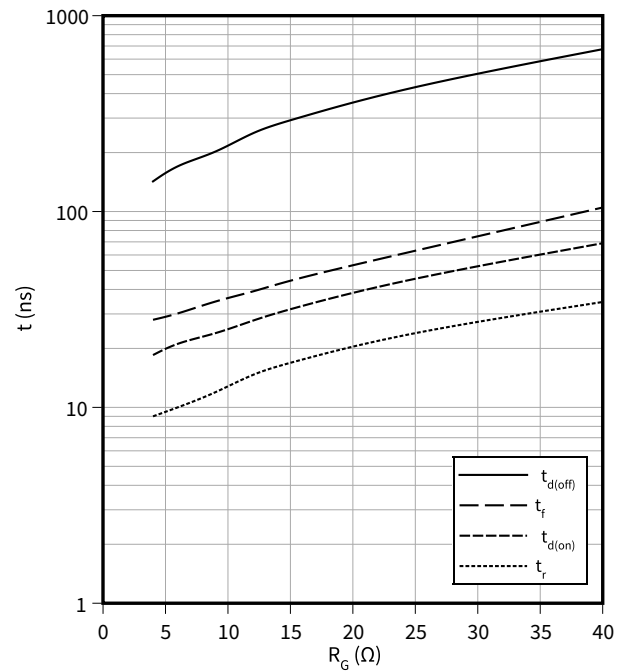
$V_{CC} = 400 \text{ V}, T_{vj} = 150 \text{ °C}, V_{GE} = 0/15 \text{ V}, R_G = 9 \text{ } \Omega$



Typical switching times as a function of gate resistor

$t = f(R_G)$

$I_C = 37.5 \text{ A}, V_{CC} = 400 \text{ V}, T_{vj} = 150 \text{ °C}, V_{GE} = 0/15 \text{ V}$

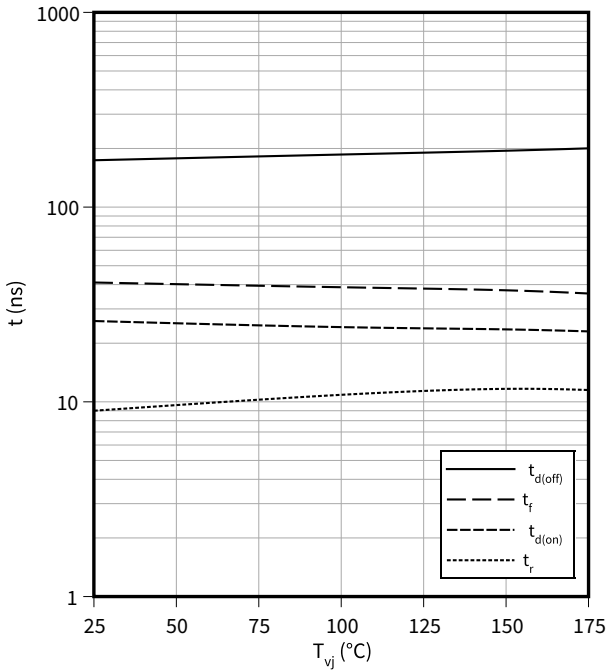


4 Characteristics diagrams

Typical switching times as a function of junction temperature

$t = f(T_{vj})$

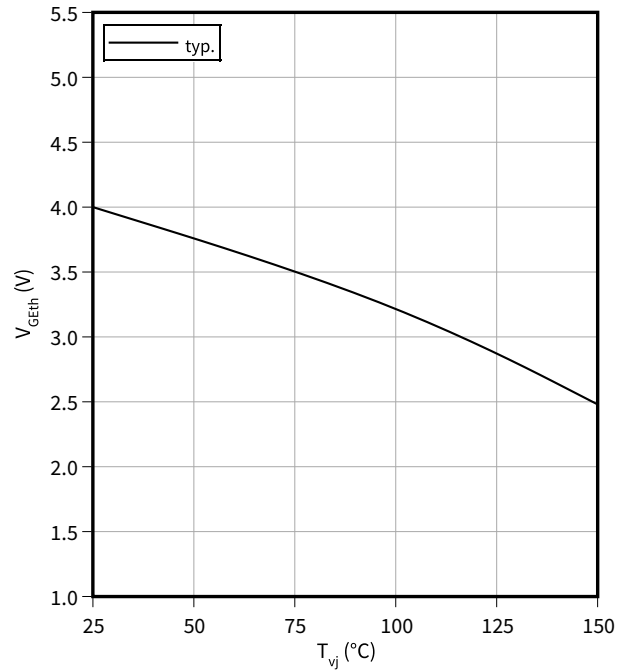
$I_C = 37.5 \text{ A}, V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_G = 9 \Omega$



Gate-emitter threshold voltage as a function of junction temperature

$V_{GEth} = f(T_{vj})$

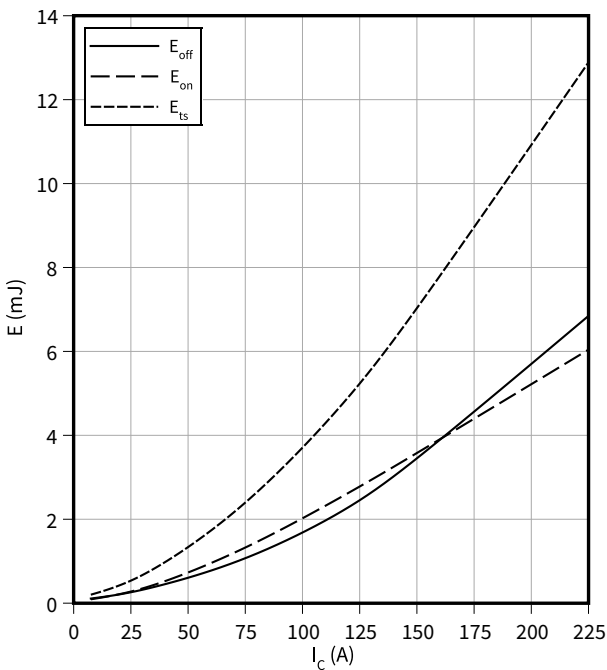
$I_C = 0.75 \text{ mA}$



Typical switching energy losses as a function of collector current

$E = f(I_C)$

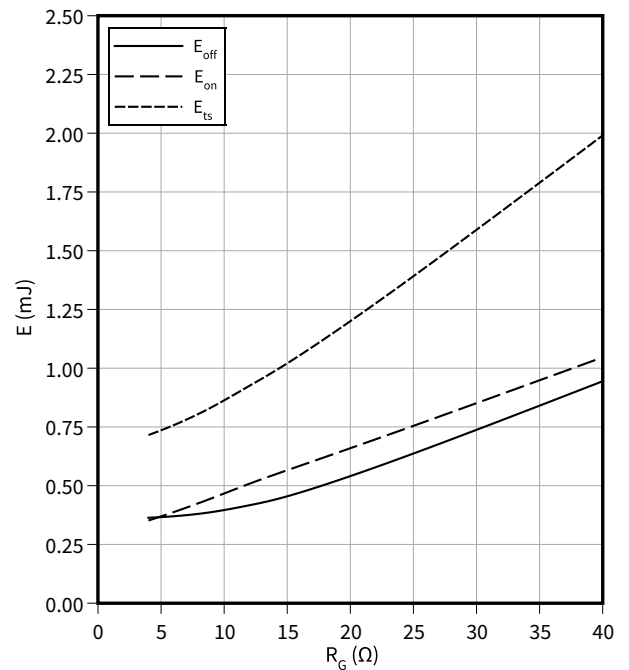
$V_{CC} = 400 \text{ V}, T_{vj} = 150 \text{ °C}, V_{GE} = 0/15 \text{ V}, R_G = 9 \Omega$



Typical switching energy losses as a function of gate resistor

$E = f(R_G)$

$I_C = 37.5 \text{ A}, V_{CC} = 400 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}$

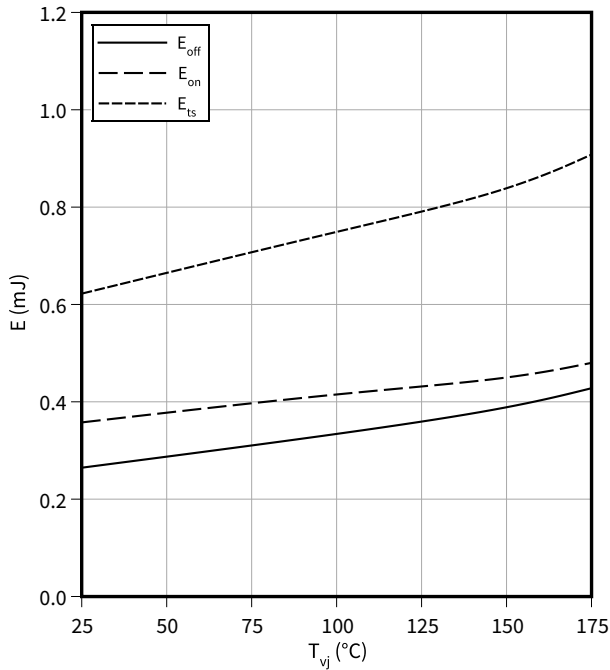


4 Characteristics diagrams

Typical switching energy losses as a function of junction temperature

$E = f(T_{vj})$

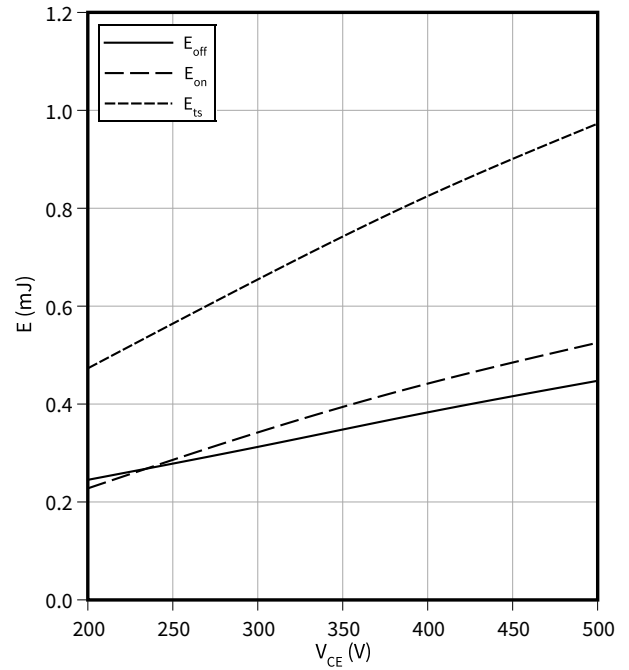
$I_C = 37.5 \text{ A}, V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_G = 9 \Omega$



Typical switching energy losses as a function of collector emitter voltage

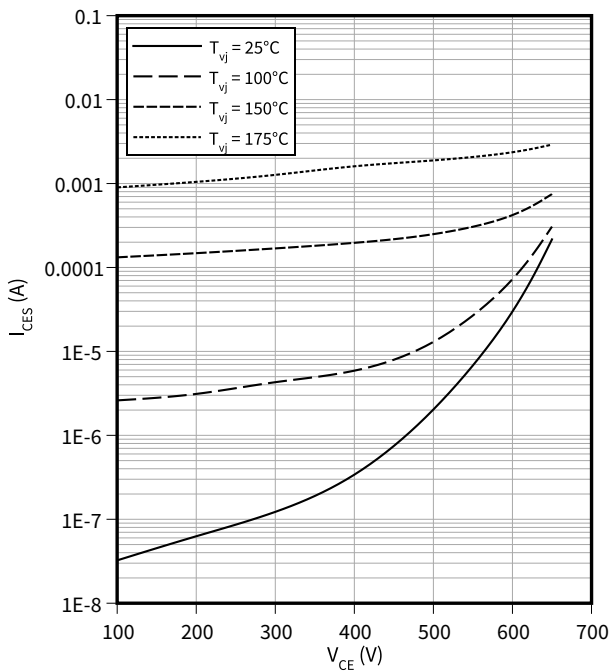
$E = f(V_{CE})$

$I_C = 37.5 \text{ A}, T_{vj} = 150 \text{ °C}, V_{GE} = 0/15 \text{ V}, R_G = 9 \Omega$



Typ. reverse current vs. reverse voltage as a function of Tvj

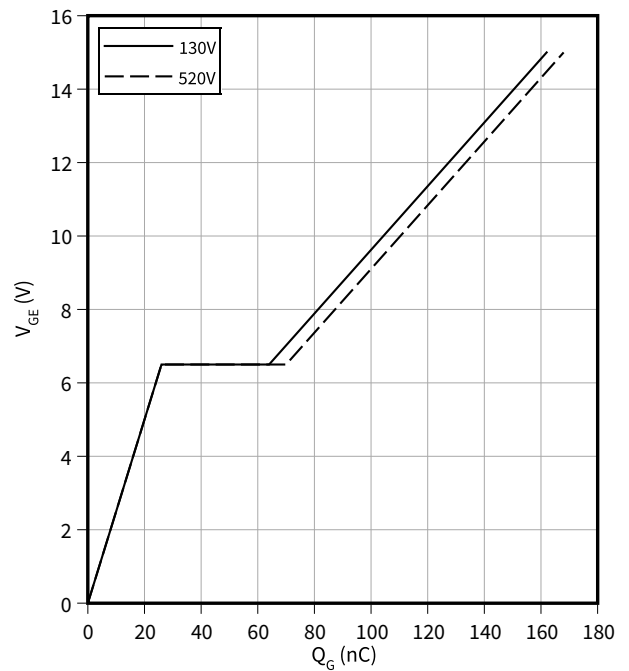
$I_{CES} = f(V_{CE})$



Typical gate charge

$V_{GE} = f(Q_G)$

$I_C = 75 \text{ A}$

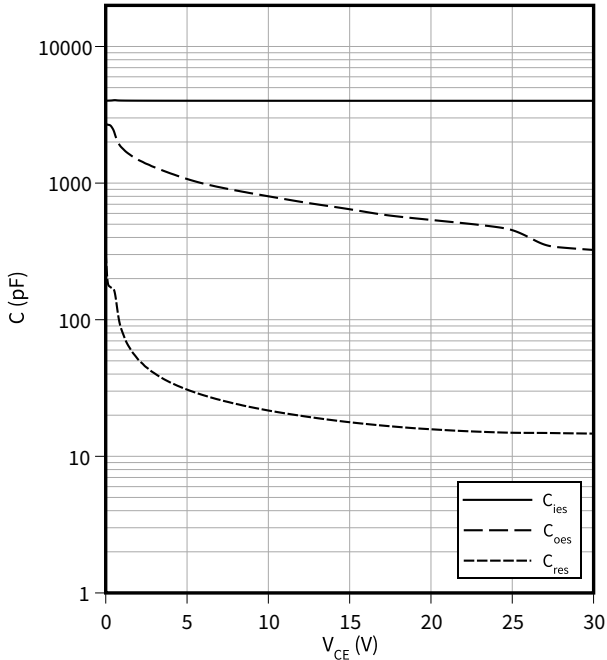


4 Characteristics diagrams

Typical capacitance as a function of collector-emitter voltage

$C = f(V_{CE})$

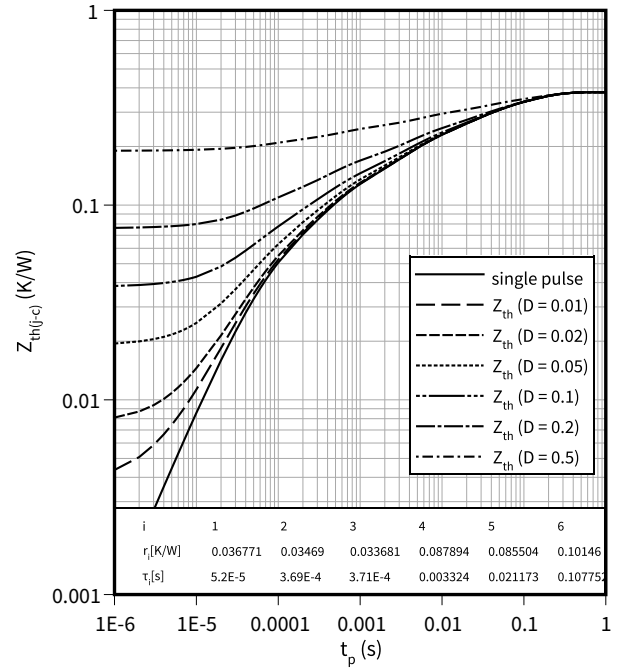
$f = 250 \text{ kHz}, V_{GE} = 0 \text{ V}$



IGBT transient thermal impedance as a function of pulse width

$Z_{th(j-c)} = f(t_p)$

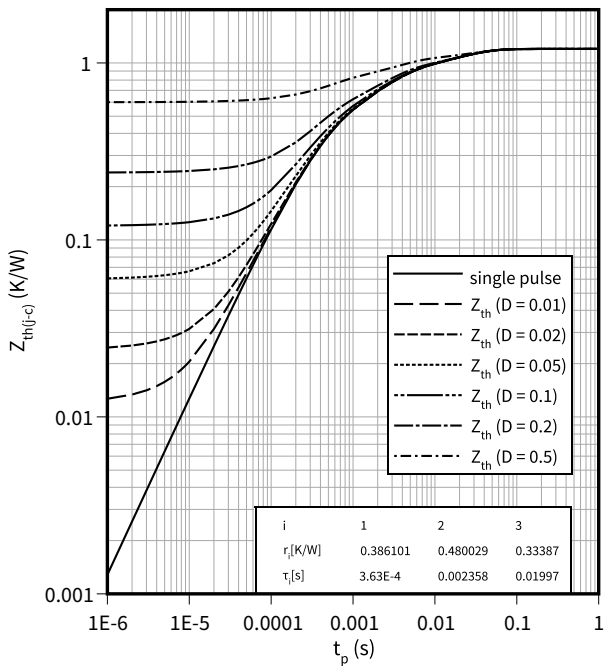
$D = t_p/T$



Diode transient thermal impedance as a function of pulse width

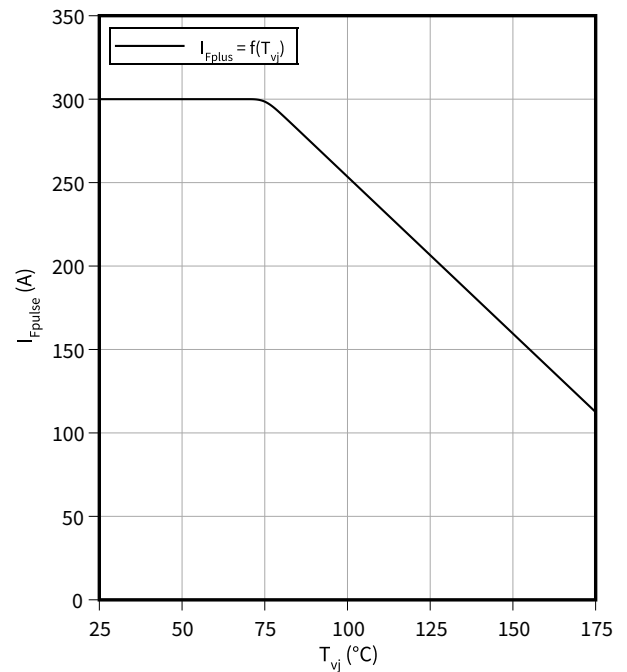
$Z_{th(j-c)} = f(t_p)$

$D = t_p/T$



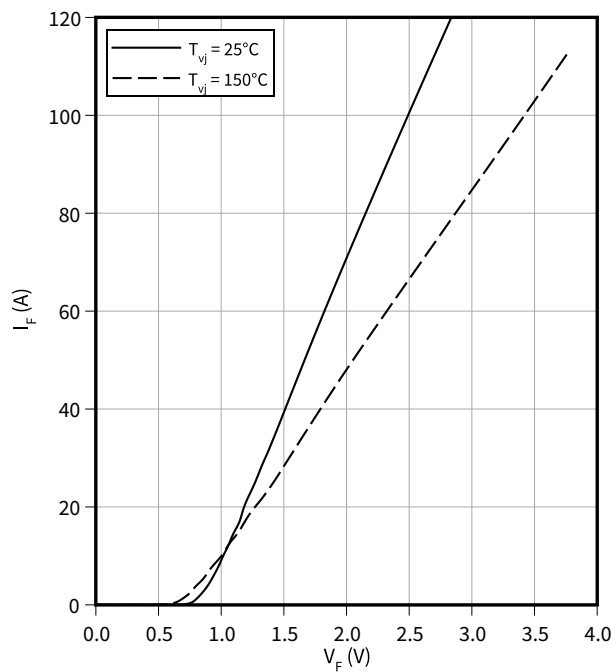
Maximum pulse current as a function of junction temperature

$I_{Fpulse} = f(T_{vj})$



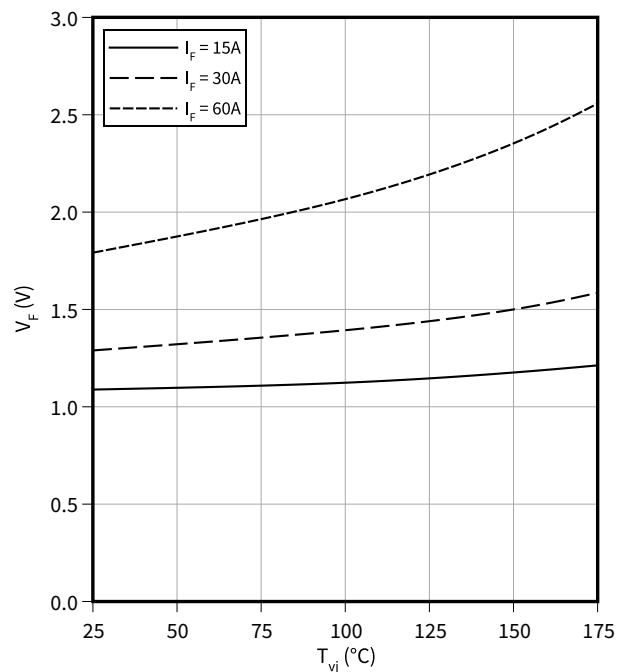
Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$



Typical diode forward voltage as a function of junction temperature

$V_F = f(T_{vj})$



5 Package outlines

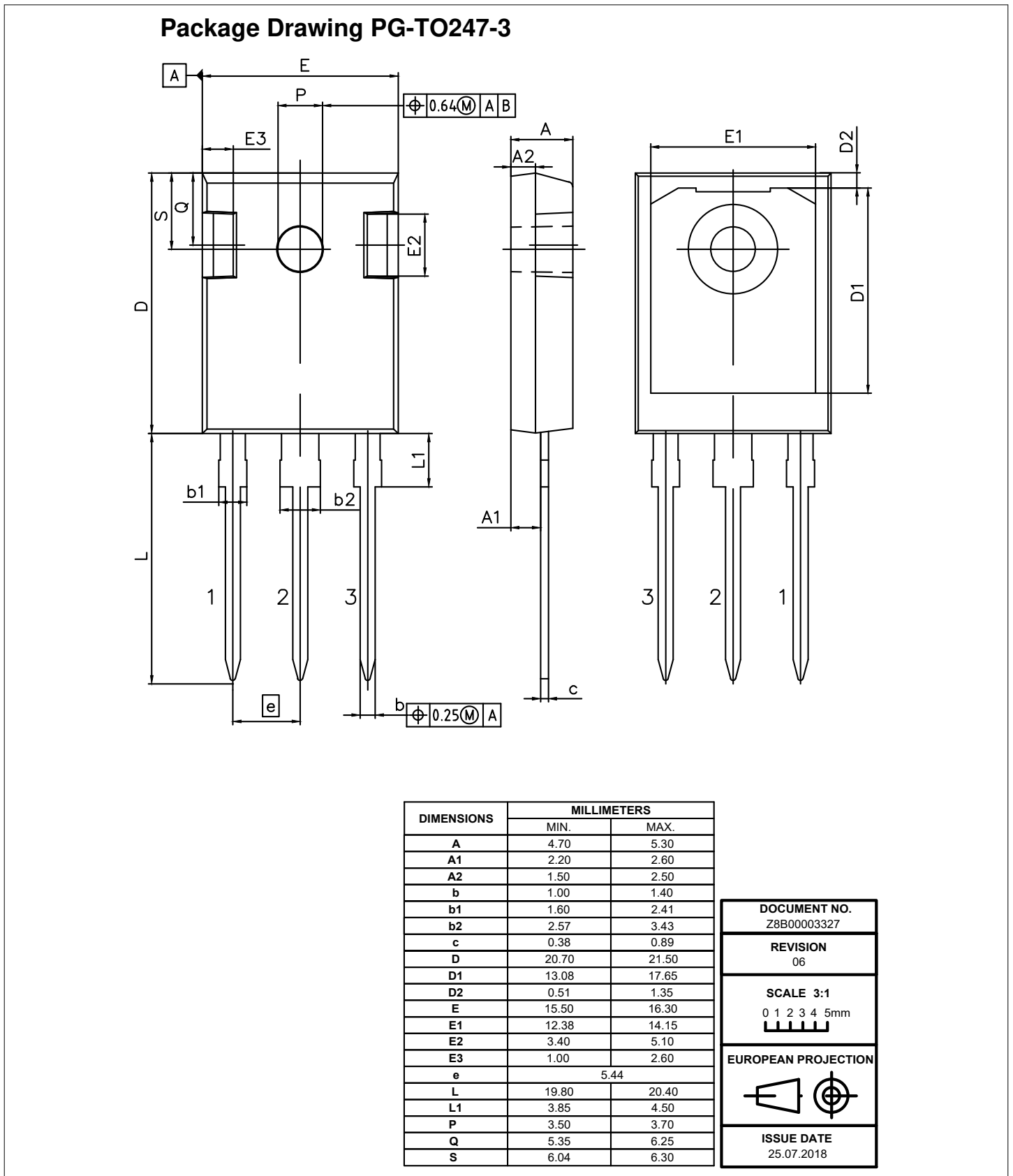


Figure 1

6 Testing conditions

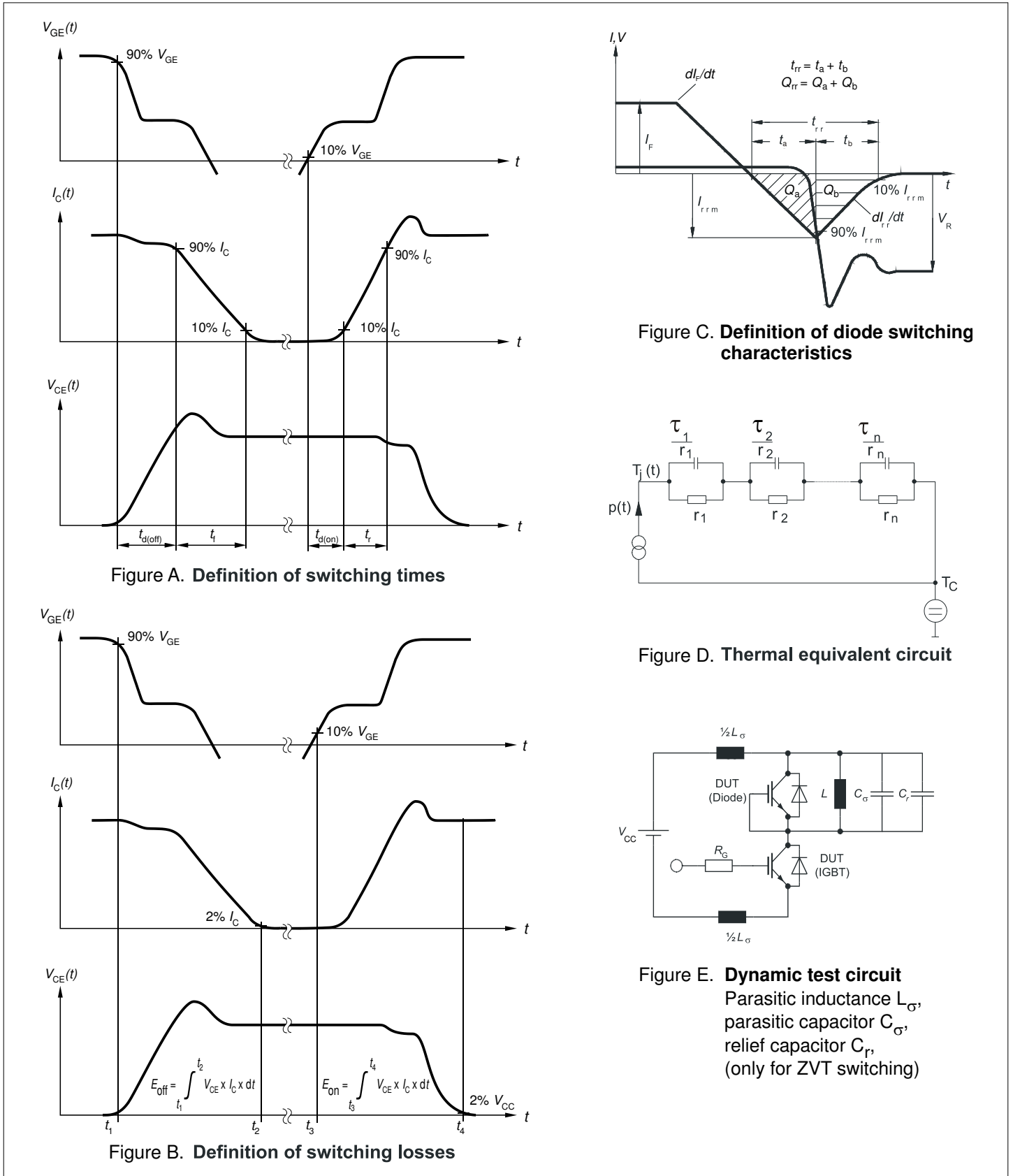


Figure 2

Revision history

| Document revision | Date of release | Description of changes |
|-------------------|-----------------|---|
| V1.1 | 2020-03-20 | Preliminary Data Sheet |
| V2.1 | 2020-07-27 | Final Data Sheet |
| n/a | 2020-11-30 | Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy |
| 1.10 | 2022-09-22 | Rename of product family name from “Hybrid CoolSiC™ IGBT” to “CoolSiC™ hybrid discrete” |

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